





Miniature 25 Amps • 1PDT To MIL-PRF-6106 DC Suppressed Coils

SPECIFICATIONS

GENERAL

Contact Arrangement	1PDT (1 Form C)
Weight	1.6 oz approx.
Designed to meet the requirem	nents of MIL-PRF-6106

PERFORMANCE

Contact Rating (Note 1)

Resistive	mps @ 28 VDC or 115/208V 400 Hz (Case Grounded)
Inductive15 Amps @) 115/208V 400 Hz (Case Grounded) 0 Amps @ 28 VDC (Case Grounded)
Motor10 A	mps @ 28 VDC or 115/208V 400 Hz (Case Grounded)
Lamp5 A	mps @ 28 VDC or 115/208V 400 Hz (Case Grounded)
Life	esistive load, 125°C

Operate/Release Time:	DC Coil
	15 ms max
Excluding bounce time at nomina	l coil voltage
Contact Bounce Time	1 ms max
@ rated	contact load, 28 VDC
Contact Voltage Drop:	
Before Life150	mv max @ 25 Amps
	and 6 VDC
After Life175	• •
	and 6 VDC
ENVIRONMENTAL	
Temperature Range	70°C to +125°C
Vibration (Note 2)	.0.12" DA 10 - 70 Hz
	30 G's 70 - 3,000 Hz
Shock (Operating)(Note 2)	•
ELECTRICAL CHARACTERIS	STICS
Duty Cycle	Continuous
Insulation Resistance	100 megohms
	@ 500V 25°C
Dielectric Strength:	-
Sea Level:	
Contact to Case	1,250 VRMS
Contact to Coil	1,250 VRMS

MIL-PRF-6106/19 QUALIFIED

80,000 Feet:

Notes

1. For other ratings consult the factory.

2. For applications requiring higher shock and vibration, consult the factory.

Coil to Case1,000 VRMS

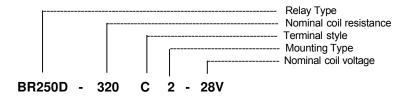
Across Open Contacts1,250 VRMS

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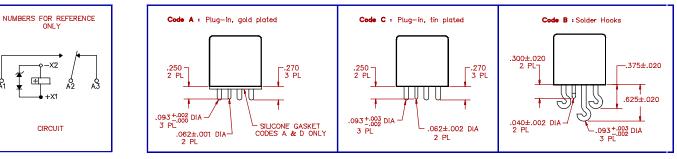


COIL DATA

MODEL BR250D PART NUMBER	BR250D-20()()-6V	BR250D-80()()-12V	BR250D-320()()-28V	BR250D-1000()()-48V
NOMINAL COIL VOLTAGE	6 VDC	12 VDC	28 VDC	48 VDC
MAXIMUM COIL VOLTAGE	8 VDC	15 VDC	29 VDC	59 VDC
PULL IN VOLTAGE (MAX @ +125°C)	4.5 VDC	9 VDC	18 VDC	36 VDC
DROP OUT VOLTAGE (MAX)	1.8 VDC	3.5 VDC	5.1 VDC	11 VDC
MAXIMUM BACK EMF	9 VDC	18 VDC	42 VDC	72 VDC
COIL RESISTANCE ± 10% @ 25°C	20 OHMS	80 OHMS	320 OHMS	1000 OHMS

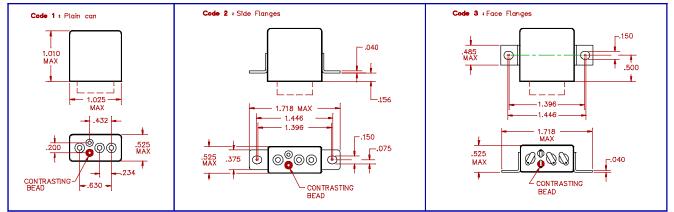


SCHEMATIC TERMINAL VIEW



TERMINAL STYLES

MOUNTING CODES



GENERAL NOTES

- Unless otherwise specified, all tests made at nominal coil voltages, @ 25°C.
- For special coil variations, switching configurations, terminals styles and mounting types, consult the factory.
- Unless otherwise specified, tolerances on decimal dimensions are ± .010".
- Specifications contained herein are subject to change without notice.



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